

BAR64-04W

Low signal distortion, surface mount RF PIN diode, series pair



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Technical documents



Simulation



Support

Product description

This Infineon cost optimized RF PIN diode is designed for low distortion switches that require to hold off large RF voltages, and is best suited for frequencies as high as 3 GHz. Its nominal 50 μm I-region width, combined with the typical 1.55 μs carrier lifetime, result in a diode with low forward resistance and low distortion characteristics.



Feature list

- Low signal distortion, charge carrier lifetime $t_{rr} = 1.55 \mu\text{s}$ (typical)
- Very low capacitance $C = 0.25 \text{ pF}$ (typical) at voltage $V_R = 0$ and frequencies $f \geq 1 \text{ GHz}$
- Low forward resistance $R_F = 2.2 \Omega$ (typical) at forward current $I_F = 10 \text{ mA}$ and frequency $f = 100 \text{ MHz}$
- Industry standard SOT323-3 package (2.1 mm x 2 mm x 0.9 mm)
- Pb-free, RoHS compliant and halogen-free

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

Optimized for low bias current RF and high-speed interface switches and attenuators

- Wireless communication
- High speed data networks

Device information

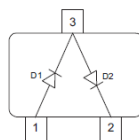


Table 1 Part information

| Product name / Ordering code | Package | Pin configuration | Marking | Pieces / Reel |
|--------------------------------|----------|-------------------|---------|---------------|
| BAR64-04W / BAR6404WH6327XTSA1 | SOT323-3 | Series pair | PPs | 3 k |

Attention: *ESD (Electrostatic discharge) sensitive device, observe handling precautions!*

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1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25\text{ °C}$, unless otherwise specified

| Parameter | Symbol | Values | | Unit | Note or test condition |
|-------------------------|-----------|--------|------|------|--|
| | | Min. | Max. | | |
| Diode reverse voltage | V_R | - | 150 | V | |
| Forward current | I_F | - | 100 | mA | |
| Total power dissipation | P_{TOT} | - | 250 | mW | $T_S \leq 123\text{ °C}$ ¹⁾ |
| Junction temperature | T_J | - | 150 | °C | |
| Operating temperature | T_{OP} | -55 | 125 | | |
| Storage temperature | T_{STG} | -55 | 150 | | |

Attention: Stresses above the maximum values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the component.

¹ T_S is the soldering point temperature.

Electrical performance in test fixture

2 Electrical performance in test fixture

2.1 DC characteristics

At $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified

Table 3 DC characteristics

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-------------------|----------|--------|------|------|---------------|------------------------------|
| | | Min. | Typ. | Max. | | |
| Breakdown voltage | V_{BR} | 150 | – | – | V | $I_R = 5\text{ }\mu\text{A}$ |
| Reverse current | I_R | – | – | 20 | nA | $V_R = 20\text{ V}$ |
| Forward voltage | V_F | – | 0.82 | – | V | $I_F = 10\text{ mA}$ |
| | | – | 0.9 | – | | $I_F = 50\text{ mA}$ |
| | | – | 0.95 | 1.1 | | $I_F = 100\text{ mA}$ |
| I-region width | W_1 | – | 50 | – | μm | |

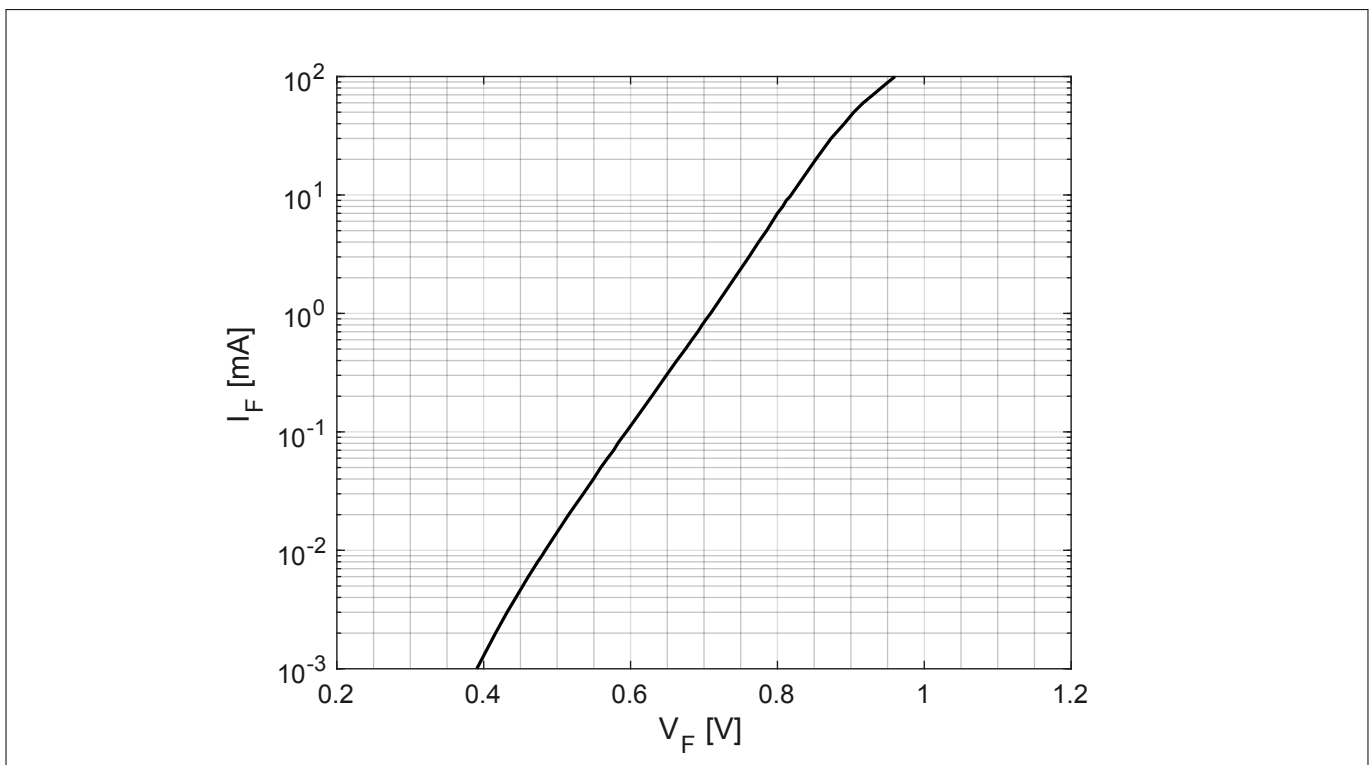


Figure 1 Forward current I_F vs. forward voltage V_F

Electrical performance in test fixture

2.2 AC characteristics

At $T_A = 25\text{ }^\circ\text{C}$, unless otherwise specified

Table 4 Key parameter

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-------------------------|-------------|--------|------|------|------|---|
| | | Min. | Typ. | Max. | | |
| Capacitance | C | - | 0.65 | - | pF | $V_R = 0\text{ V}, f = 1\text{ MHz}$ |
| | | - | 0.26 | 0.35 | | $V_R = 20\text{ V}, f = 1\text{ MHz}$ |
| Forward resistance | R_F | - | 10.2 | 20 | | $I_F = 1\text{ mA}, f = 100\text{ MHz}$ |
| | | - | 4.4 | - | | $I_F = 3\text{ mA}, f = 100\text{ MHz}$ |
| | | - | 3.2 | - | | $I_F = 5\text{ mA}, f = 100\text{ MHz}$ |
| | | - | 2.2 | 2.8 | | $I_F = 10\text{ mA}, f = 100\text{ MHz}$ |
| | | - | - | 1.35 | | $I_F = 100\text{ mA}, f = 100\text{ MHz}$ |
| Inductance | L_S | - | 1.4 | - | nH | |
| Charge carrier lifetime | τ_{rr} | - | 1550 | - | ns | $I_F = 10\text{ mA}, I_R = 6\text{ mA}$, measured at $I_R = 3\text{ mA}$, $R_L = 100\ \Omega$ |

Table 5 AC parameter at $f = 1\text{ GHz}$

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-----------------------------|----------|--------|------|------|------------|------------------------|
| | | Min. | Typ. | Max. | | |
| Capacitance | C | - | 0.23 | - | pF | $V_R = 0\text{ V}$ |
| Reverse parallel resistance | R_P | - | 3.5 | - | k Ω | $V_R = 0\text{ V}$ |
| Forward resistance | R_F | - | 10.2 | - | Ω | $I_F = 1\text{ mA}$ |
| | | - | 4.4 | - | | $I_F = 3\text{ mA}$ |
| | | - | 3.3 | - | | $I_F = 5\text{ mA}$ |
| | | - | 2.4 | - | | $I_F = 10\text{ mA}$ |
| Insertion loss | I_L | - | 0.84 | - | dB | $I_F = 1\text{ mA}$ |
| | | - | 0.41 | - | | $I_F = 3\text{ mA}$ |
| | | - | 0.31 | - | | $I_F = 5\text{ mA}$ |
| | | - | 0.24 | - | | $I_F = 10\text{ mA}$ |
| Isolation | I_{SO} | - | 18.6 | - | | $V_R = 0\text{ V}$ |

Table 6 AC parameter at $f = 1.8\text{ GHz}$

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-----------------------------|--------|--------|------|------|------------|------------------------|
| | | Min. | Typ. | Max. | | |
| Capacitance | C | - | 0.23 | - | pF | $V_R = 0\text{ V}$ |
| Reverse parallel resistance | R_P | - | 2.8 | - | k Ω | $V_R = 0\text{ V}$ |

Electrical performance in test fixture

Table 6 AC parameter at $f = 1.8$ GHz (continued)

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|--------------------|----------|--------|------|------|----------|------------------------|
| | | Min. | Typ. | Max. | | |
| Forward resistance | R_F | - | 10.2 | - | Ω | $I_F = 1$ mA |
| | | - | 4.5 | - | | $I_F = 3$ mA |
| | | - | 3.4 | - | | $I_F = 5$ mA |
| | | - | 2.5 | - | | $I_F = 10$ mA |
| Insertion loss | I_L | - | 0.89 | - | dB | $I_F = 1$ mA |
| | | - | 0.46 | - | | $I_F = 3$ mA |
| | | - | 0.37 | - | | $I_F = 5$ mA |
| | | - | 0.29 | - | | $I_F = 10$ mA |
| Isolation | I_{SO} | - | 13.7 | - | | $V_R = 0$ V |

Table 7 AC parameter at $f = 2.5$ GHz

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|-----------------------------|----------|--------|------|------|------------|------------------------|
| | | Min. | Typ. | Max. | | |
| Capacitance | C | - | 0.23 | - | pF | $V_R = 0$ V |
| Reverse parallel resistance | R_P | - | 2.5 | - | k Ω | $V_R = 0$ V |
| Forward resistance | R_F | - | 10.2 | - | Ω | $I_F = 1$ mA |
| | | - | 4.7 | - | | $I_F = 3$ mA |
| | | - | 3.5 | - | | $I_F = 5$ mA |
| | | - | 2.6 | - | | $I_F = 10$ mA |
| Insertion loss | I_L | - | 0.94 | - | dB | $I_F = 1$ mA |
| | | - | 0.53 | - | | $I_F = 3$ mA |
| | | - | 0.43 | - | | $I_F = 5$ mA |
| | | - | 0.36 | - | | $I_F = 10$ mA |
| Isolation | I_{SO} | - | 11 | - | | $V_R = 0$ V |

Electrical performance in test fixture

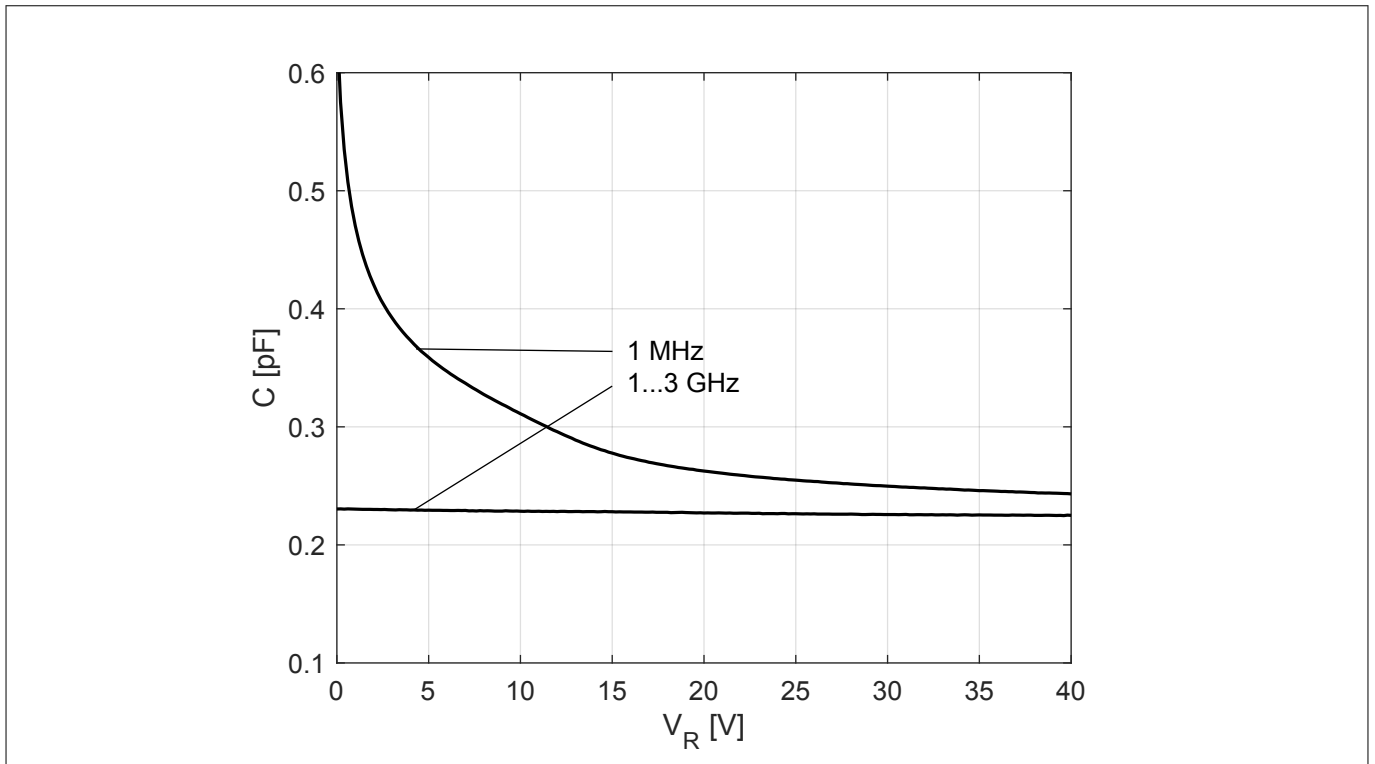


Figure 2 Capacitance C vs. reverse voltage V_R at different frequencies

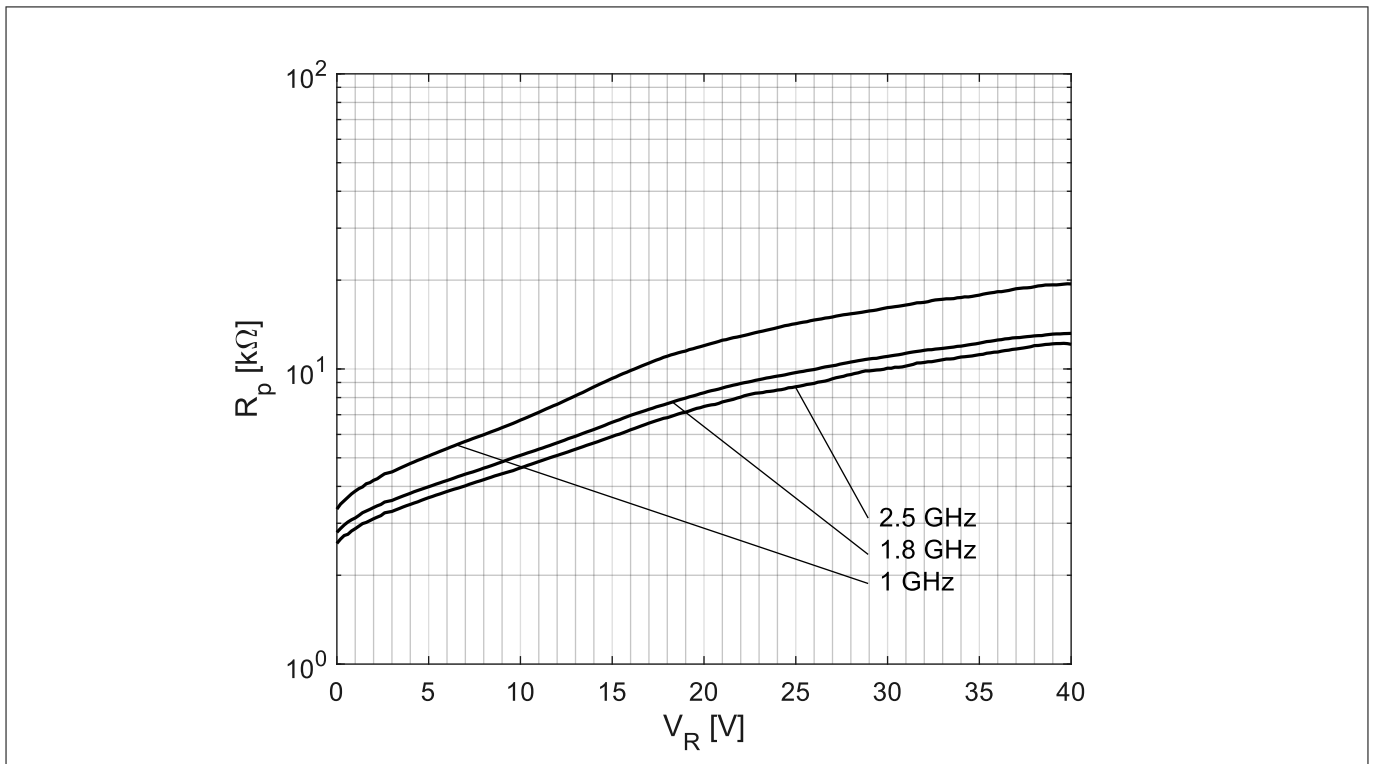


Figure 3 Reverse parallel resistance R_p vs. reverse voltage V_R at different frequencies

Electrical performance in test fixture

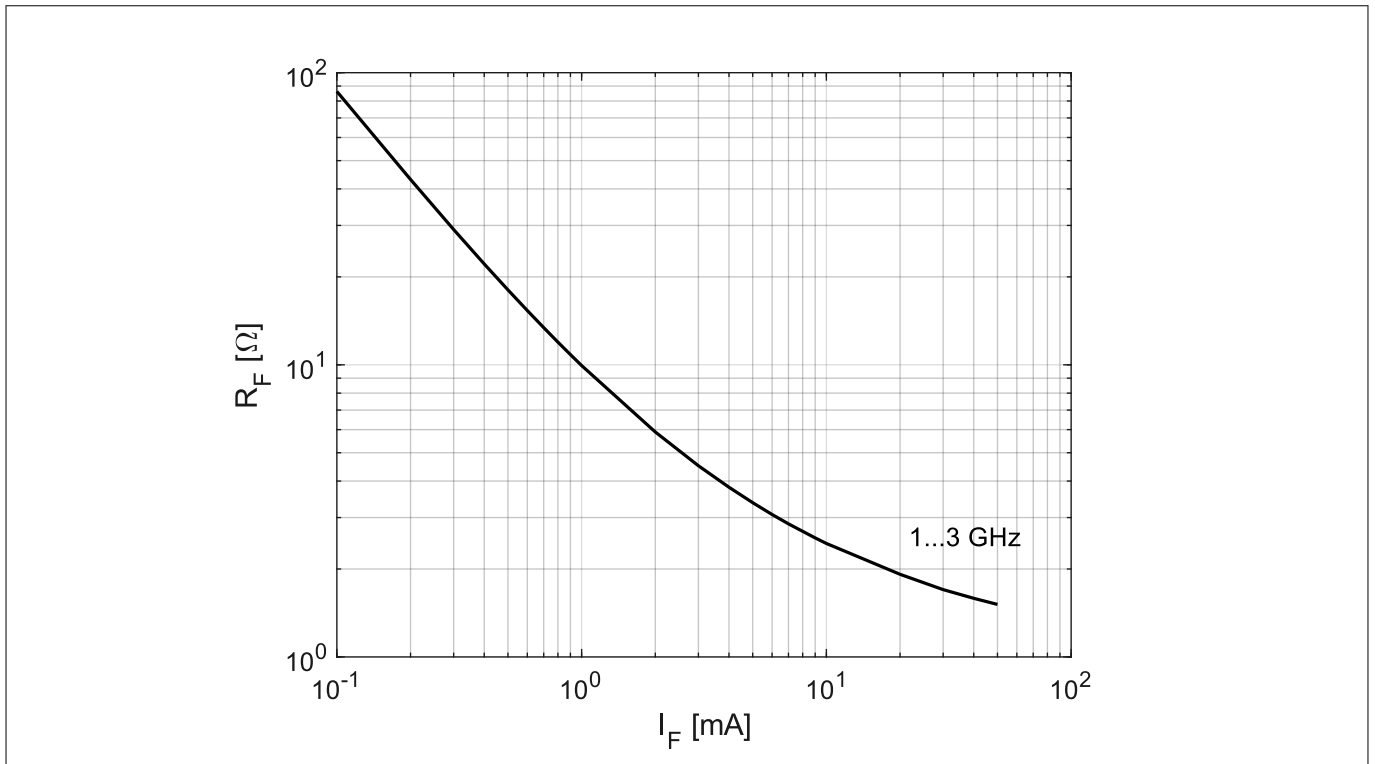


Figure 4 Forward resistance R_F vs. forward current I_F at different frequencies

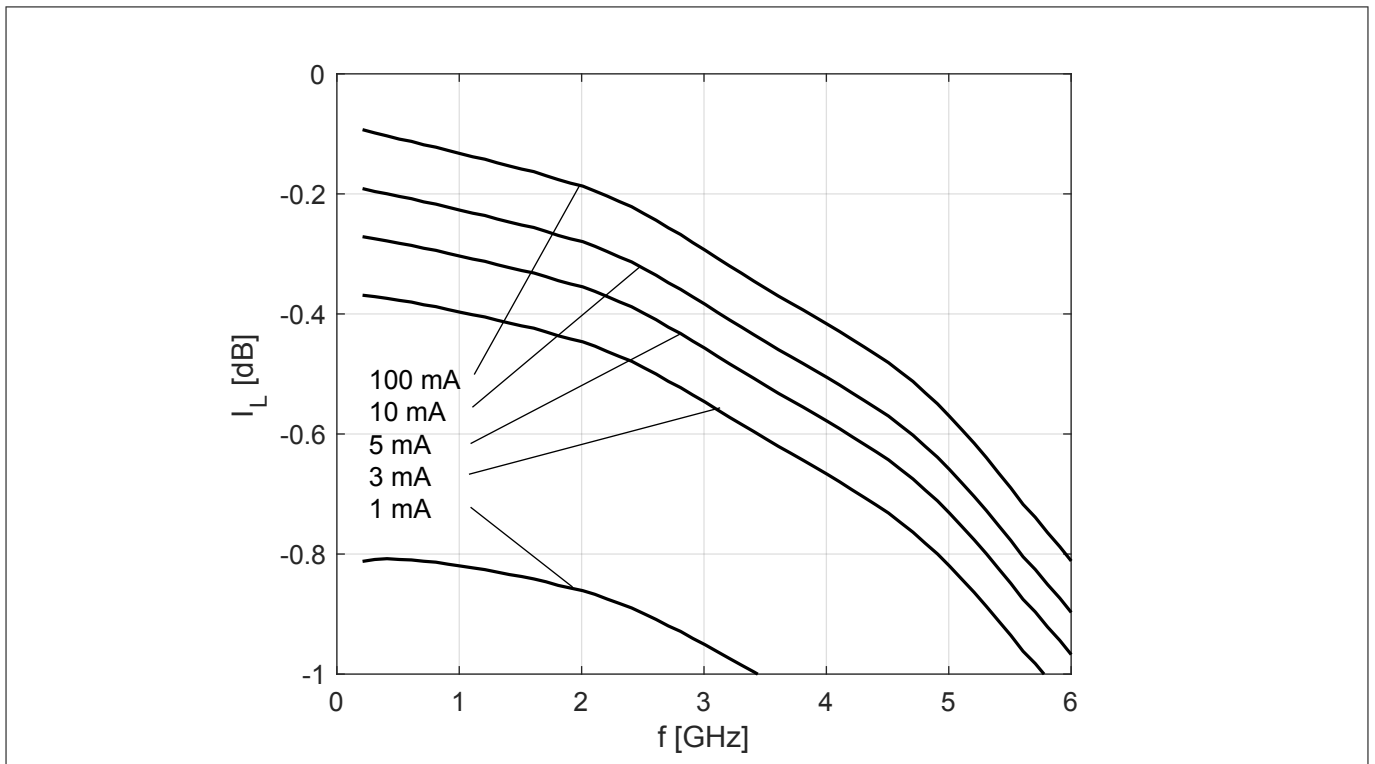


Figure 5 Insertion loss I_L vs. frequency f at different forward currents

Electrical performance in test fixture

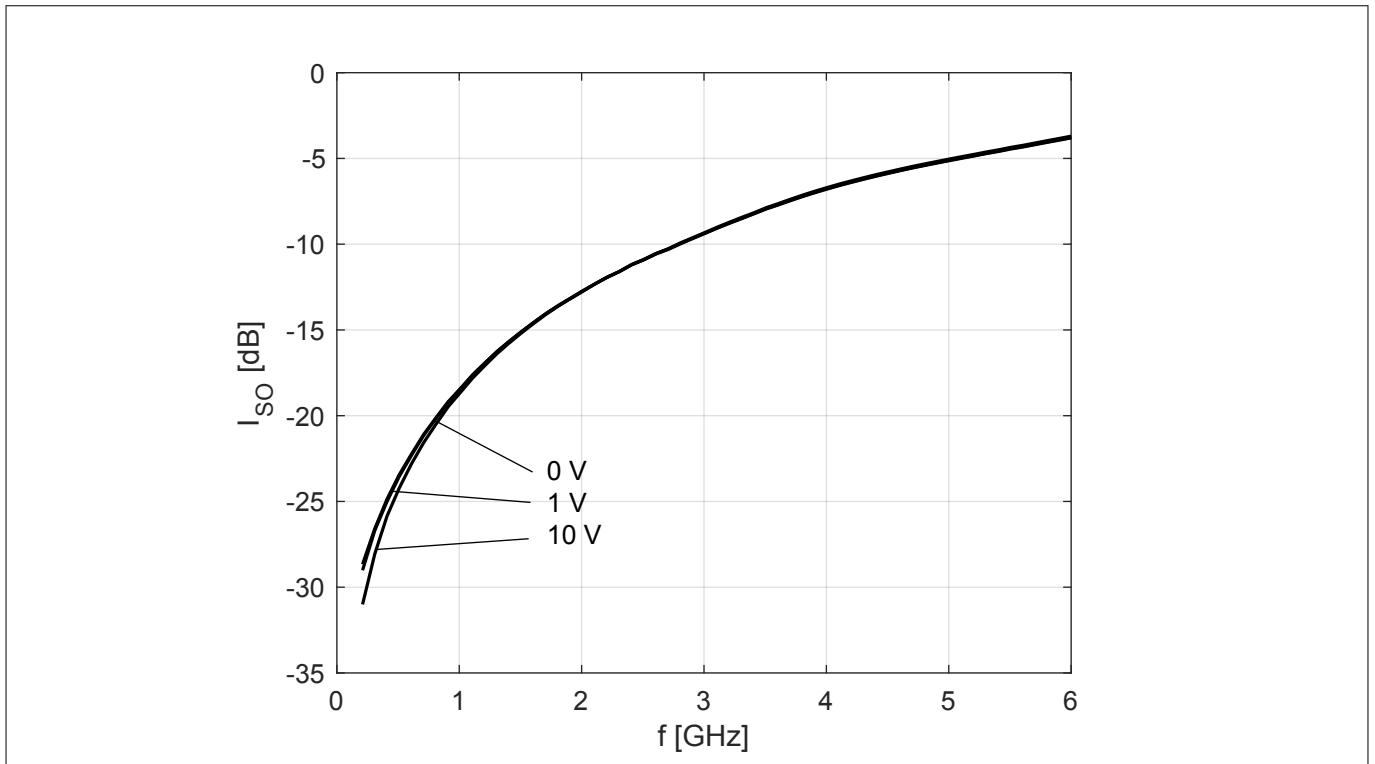


Figure 6 Isolation I_{50} vs. frequency f at different reverse voltages

Note: The curves shown in this chapter have been generated using typical devices but shall not be understood as a guarantee that all devices have identical characteristic curves.

Thermal characteristics

3 Thermal characteristics

Table 8 Thermal resistance

| Parameter | Symbol | Values | | | Unit | Note or test condition |
|---|------------|--------|------|------|------|-------------------------------------|
| | | Min. | Typ. | Max. | | |
| Thermal resistance (junction - soldering point) | R_{thJS} | - | 105 | - | K/W | $T_S = 123\text{ °C}$ ²⁾ |

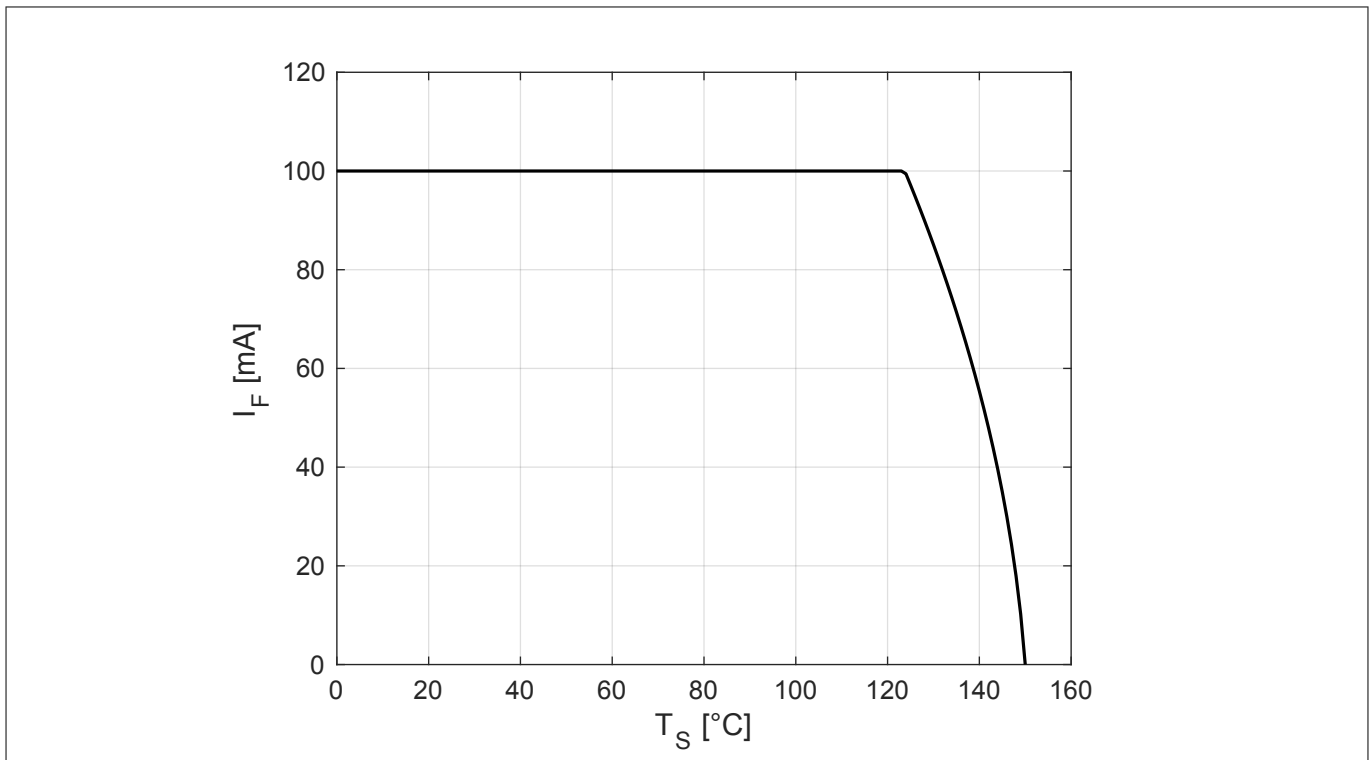


Figure 7 Permissible forward current I_F in DC operation

²⁾ For R_{thJS} in other conditions refer to the curves in this chapter.

Thermal characteristics

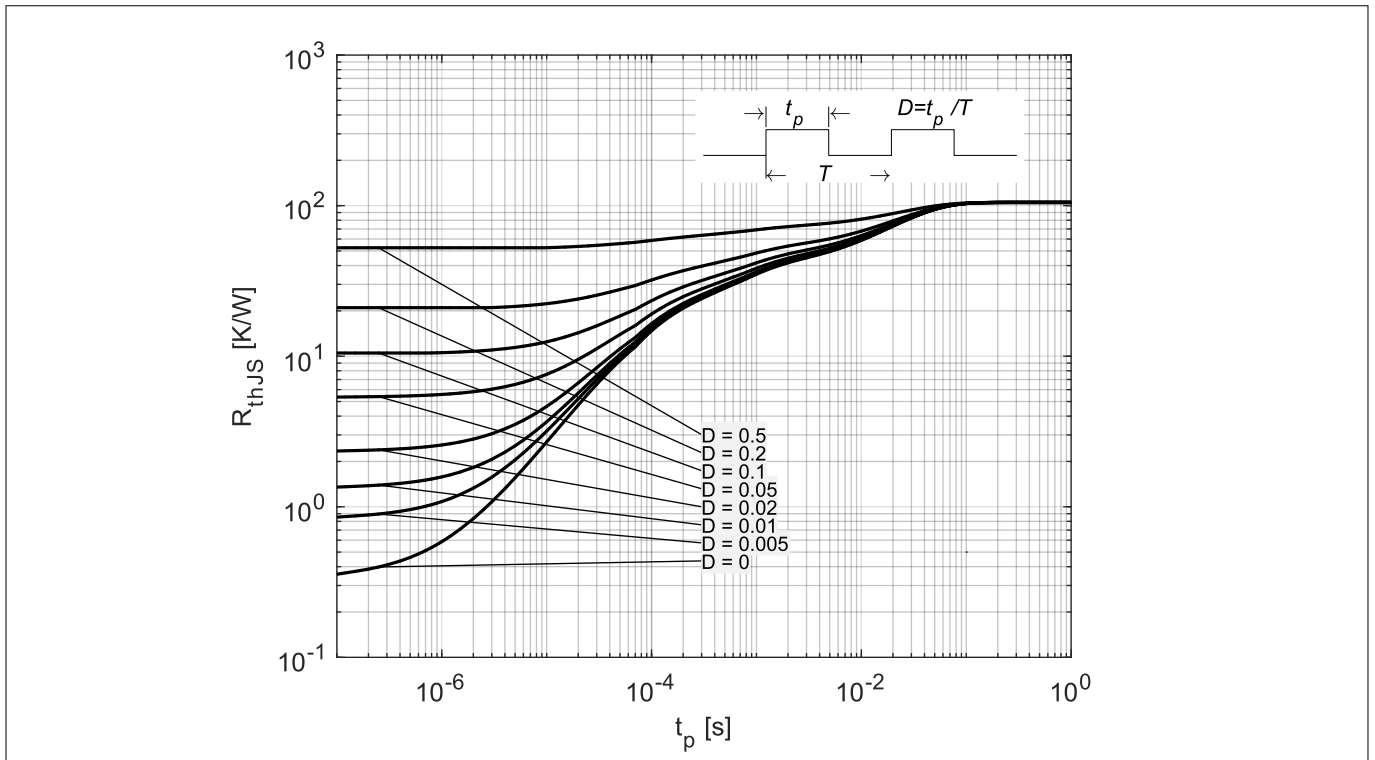


Figure 8 Thermal resistance R_{thJS} in pulse operation

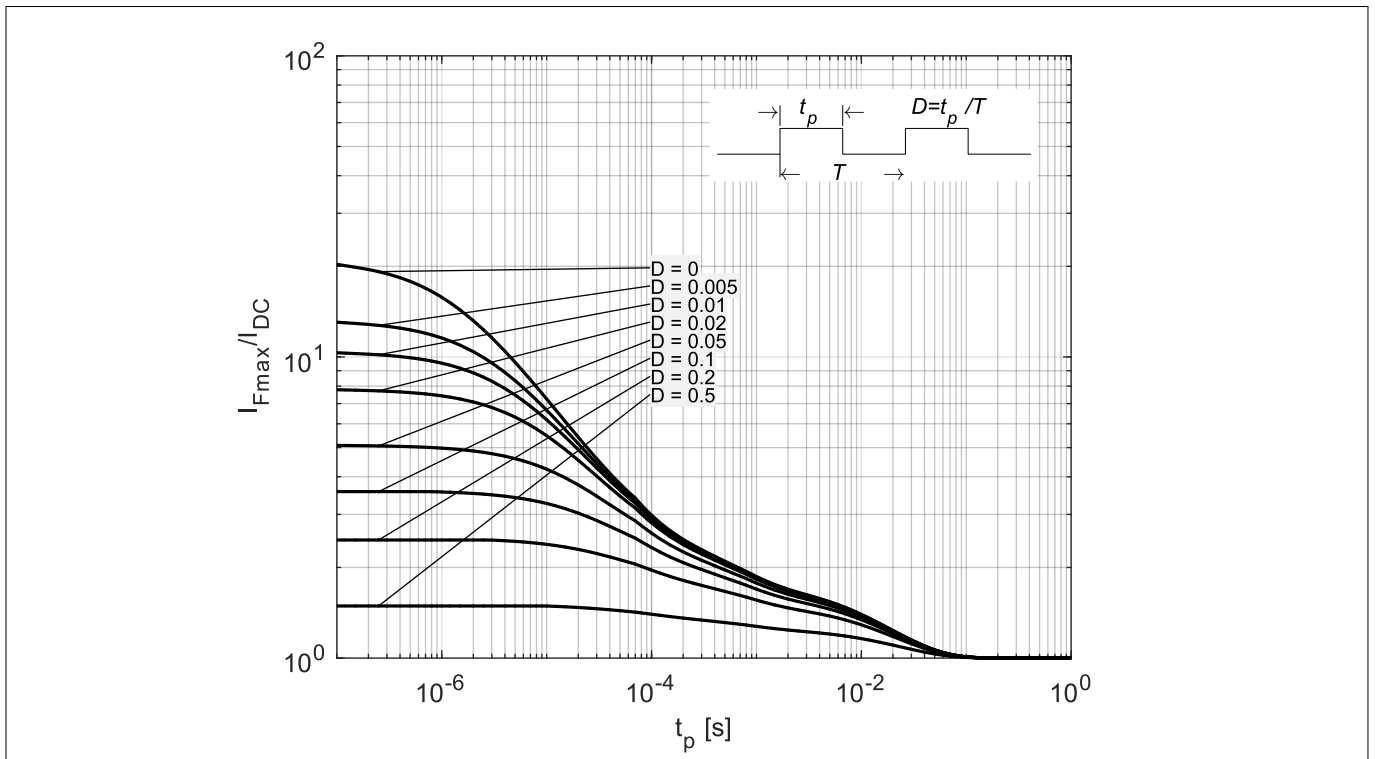


Figure 9 Permissible forward current ratio I_{Fmax}/I_{DC} in pulse operation

Package information SOT323-3

4 Package information SOT323-3

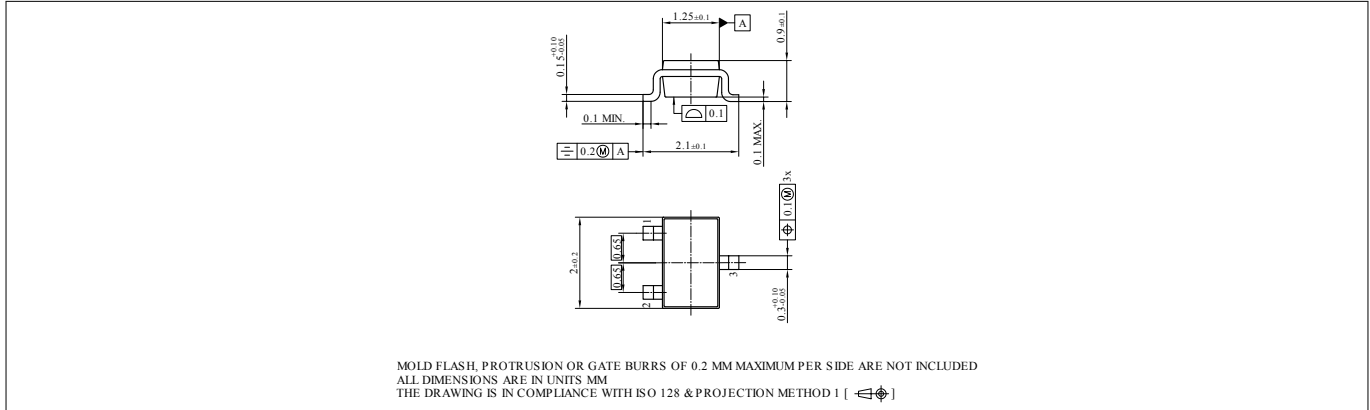


Figure 10 Package outline

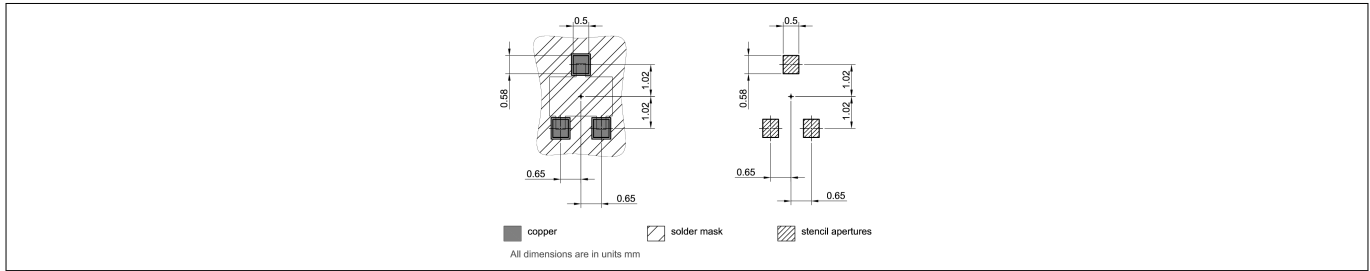


Figure 11 Foot print

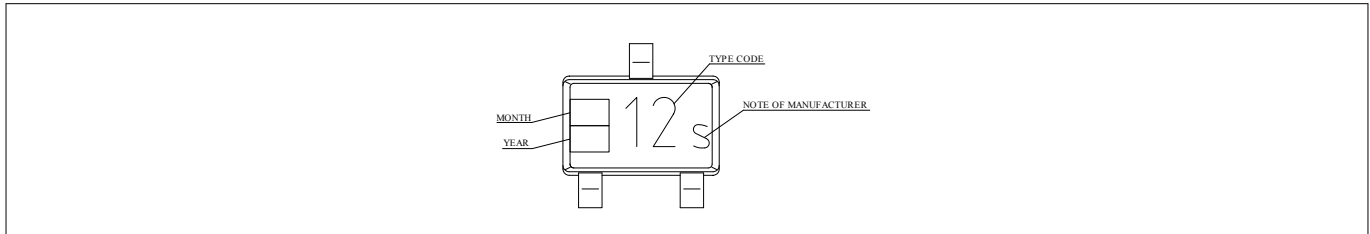


Figure 12 Marking layout example

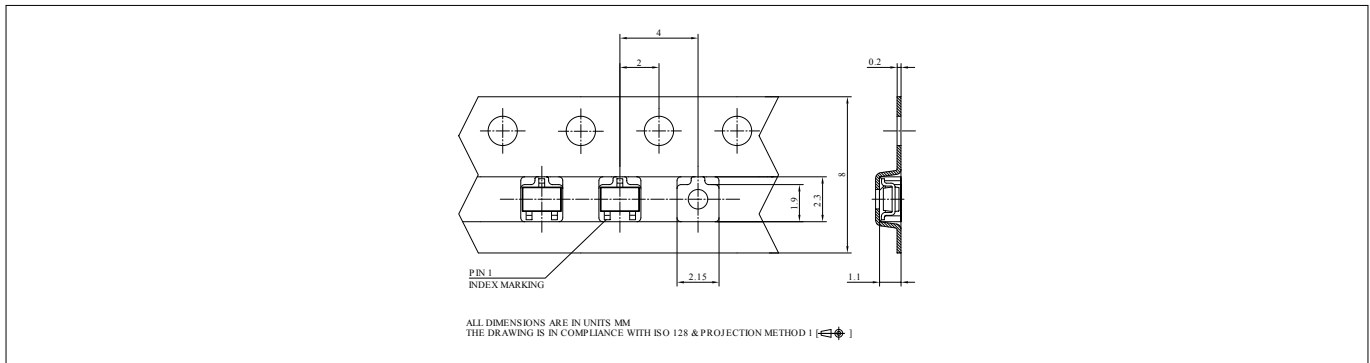


Figure 13 Tape information

Revision history**Revision history**

| Document version | Date of release | Description of changes |
|-------------------------|------------------------|--|
| 1.0 | 2018-09-07 | <ul style="list-style-type: none">• Change from series datasheet to individual one• Initial release of datasheet• Typical values and curves updated to the values of the production (No product or process change behind)• Maximum/typical values added• Typical curves/values removed |
| 1.1 | 2019-01-21 | Product description, feature list and potential application section reworked |

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